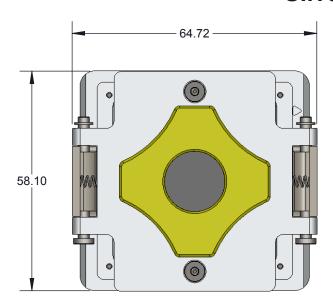
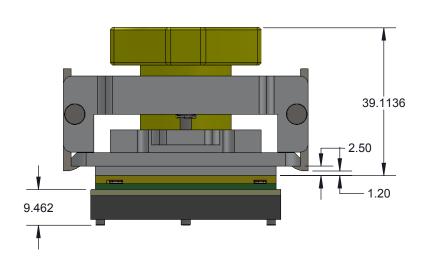
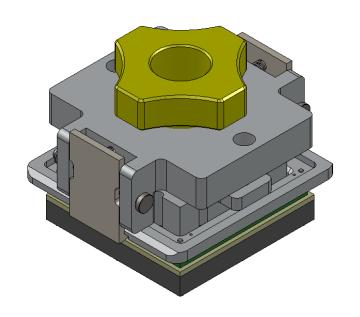
Silver Ball Matrix Socket



Features

- Wide temperature range (-55C to +150C).
 Current capability is 4A per pin .
 Excellent signal integrity at high frequencies.
 Low and stable contact resistance for reliable production yield.
 Highly compliant to accommodate wide co-planarity variations.





Description: SM socket for 680 position 39x39 array 40x40mm, 1mm pitch BGA

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

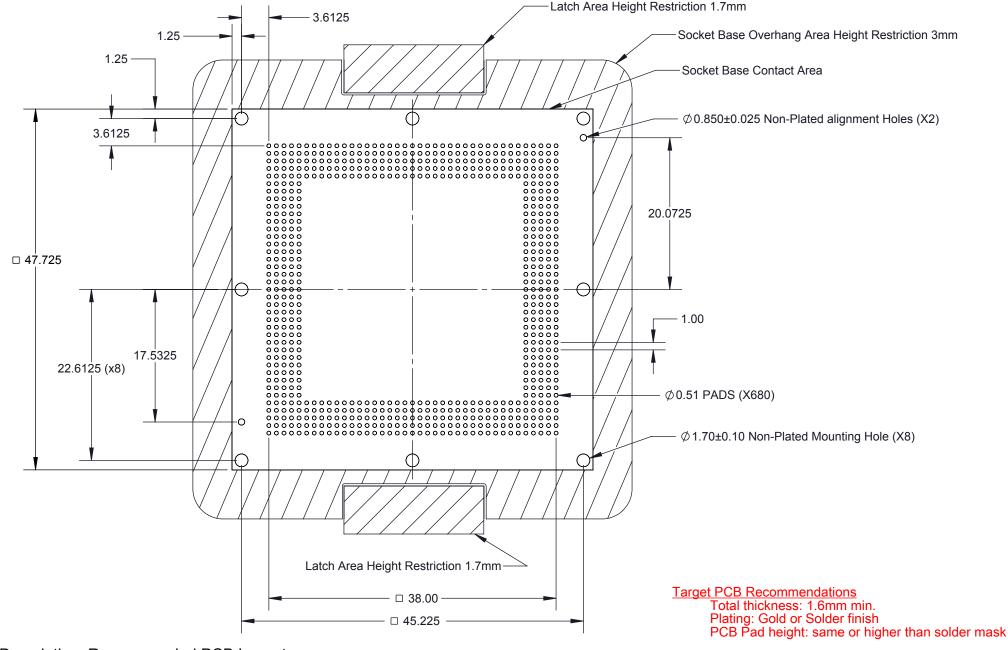
Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

SM-BGA-9009 Drawin					
	Ironwood Electronics, Inc				
7.75	Tele: (800) 404-0204				

ics, Inc. -0204 www.ironwoodelectronics.com

Material: N/A Finish: N/A Weight: 245.83

STATUS: Released	SHEET: 1 OF 5	REV. B
ENG: E. Smolentseva	DRAWN BY: E. Smolentseva	SCALE: 1:1
FILE: SM-BGA-9009 Dwg	DATE: 4/9/12	



Description: Recommended PCB Layout

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

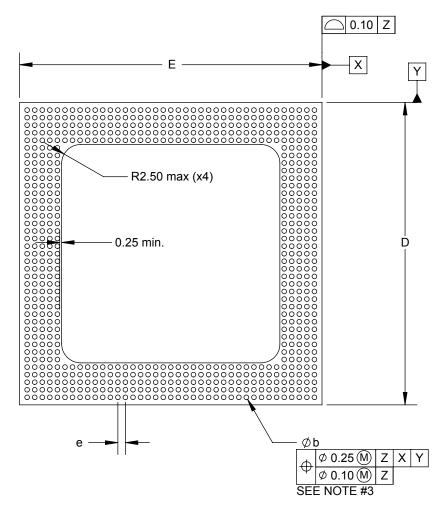
Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

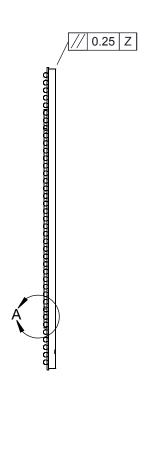
SM-BGA-9009 Drawing

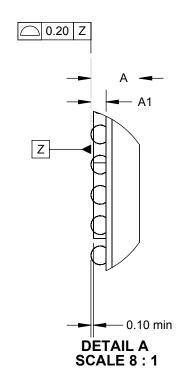
Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com Material: N/A Finish: N/A Weight: 245.83

STATUS: Released	SHEET: 2 OF 5	REV. B
ENG: E. Smolentseva	DRAWN BY: E. Smolentseva	SCALE: 2:1
FILE: SM-BGA-9009 Dwg	DATE: 4/9/12	

Ironwood Package code is BGA680C2







DIM	DIM Minimum Maxim			
Α	1.62 ref.			
A1	0.4 0.6			
b	0.5	0.7		
D	40.0 +/- 0.2mm			
E	40.0 +/- 0.2mm			
е	1.00			
ARRAY	39 x 39			
PIN COUNT		680		

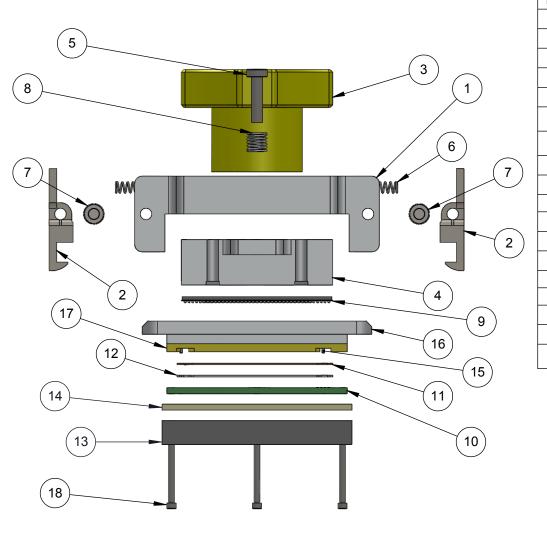
- 1. Dimensions are in millimeters.
- 2. Interpret dimensions and tolerances per ASME Y14.5M-1994.
- 3. Dimension b is measured at the maximum solder ball diameter, parallel to datum plane Z.
- 4. Datum Z (seating plane) is defined by the spherical crowns of the solder balls.
- 5. Parallelism measurement shall exclude any effect of mark on top surface of package.

Description: Compatible BGA

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

<u>Tolerances</u>: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

SM-BGA-9009 Drawing		Finish: N/A	STATUS: Released	SHEET: 3 OF 5	REV. B
Ironwood Electronics, Inc. Tele: (800) 404-0204	ENG: E. Smolentseva		DRAWN BY: E. Smolentseva	SCALE: 2:1	
	vww.ironwoodelectronics.com		FILE: SM-BGA-9009 Dwg	DATE: 4/9/12	



DESCRIPTION	Material
Clam Shell	7075-T6 Aluminum Alloy
Latch	7075-T6 Aluminum Alloy
Compression Screw	7075-T6 Aluminum Alloy
Compression Plate	7075-T6 Aluminum Alloy
Screw, M3 x 12mm, Low Head Cap, SS	18-8 Stainless Steel
Precision Compression Spring, Zinc-Plated Music Wire, 1/2" Length, .12" OD, .016" Wire	Zinc Plated Music Wire
Hinge Pin and Snap Ring, 3mm OD, 30mm long, 1045 Stl, Blk Oxide	AISI 1045 Steel, cold drawn
Spring Clamshell lid assembly	Steel Music Wire
test chip	FR4 High temp
Test PCB	FR4 Standard
SM socket ball guide 40mm 39x39 1mm BGA680	Kapton Polyimide/Cirlex
Silmat for 40mm, 39x39 1mm pitch BGA680	Silmat
Backing Plate	7075-T6 Aluminum Alloy
Insulation Plate, 50.225 X 50.225	FR4
Dowel Pin, 1/32" x 3/16", SS	Chrome Stainless Steel
Socket Base 40mm IC Clamshell Double latch	7075-T6 Aluminum Alloy
IC guide for 40mm device	Torlon 4203
#0-80 X .625 LG, SOC HD CAP SCREW, ALLOY STL, BLK OXIDE	Alloy Steel
	Clam Shell Latch Compression Screw Compression Plate Screw, M3 x 12mm, Low Head Cap, SS Precision Compression Spring, Zinc-Plated Music Wire, 1/2" Length, .12" OD, .016" Wire Hinge Pin and Snap Ring, 3mm OD, 30mm long, 1045 Stl, Blk Oxide Spring Clamshell lid assembly test chip Test PCB SM socket ball guide 40mm 39x39 1mm BGA680 Silmat for 40mm, 39x39 1mm pitch BGA680 Backing Plate Insulation Plate, 50.225 X 50.225 Dowel Pin, 1/32" x 3/16", SS Socket Base 40mm IC Clamshell Double latch IC guide for 40mm device #0-80 X .625 LG, SOC HD CAP SCREW, ALLOY STL,

Ø 1.70±0.10 (x8)

22.94 (x4)

22.94 (x4)

250

1.59

Insulation Plate Specification

Description: Socket Assy, Insulation Plate

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

SM-BGA-9009 Drawing



Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com Material: N/A Finish: N/A Weight: 245.83

STATUS: Released	SHEET: 4 OF 5	REV. B
ENG: E. Smolentseva	DRAWN BY: E. Smolentseva	SCALE: 1:1
FILE: SM-BGA-9009 Dwg	DATE: 4/9/12	

Rev	Date	Initials	Description
Α	04/09/12	ELS	Original
В	12/23/14	DH	Changed IC Guide material from Ultem to torlon

Description: Revisions

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001*], Pitches (from true position) ±0.025mm [±0.001*], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005*] unless stated otherwise. Materials and specifications are subject to change without notice.

SM-BGA-9009 Drawing	Material:	STATUS: Released	SHEET: 5 OF 5	REV. B
Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com	Finish: Weight:	ENG: E. Smolentseva	DRAWN BY: E. Smolentseva	SCALE: 1:1
	weight.	FILE: SM-BGA-9009 Dwg	DATE: 4/9/12	